

Summary of QPro™ Virtex™-II Features

- Industry's first military-grade platform FPGA solution
- Certified to MIL-PRF-38535 (Qualified Manufacturer Listing)
- 100% factory tested
- Guaranteed over the full military temperature range (–55°C to +125°C) or industrial temperature range (–40°C to +100°C)
- Ceramic and plastic wire-bond and flip-chip grid array packages
- IP-immersion architecture
 - Densities from 1M to 6M system gates
 - 300+ MHz internal clock speed (Advance Data)
 - 622+ Mb/s I/O (Advance Data)
- SelectRAM™ Memory Hierarchy
 - 2.5 Mb of dual-port RAM in 18 Kbit block SelectRAM resources
 - Up to 1 Mb of distributed SelectRAM resources
- High-performance interfaces to external memory
 - DRAM interfaces
 - SDR/DDR SDRAM
 - Network FCRAM
 - Reduced Latency DRAM
 - SRAM interfaces
 - SDR/DDR SRAM
 - QDR SRAM
 - CAM interfaces
- Arithmetic functions
 - Dedicated 18-bit x 18-bit multiplier blocks
 - Fast look-ahead carry logic chains
- Flexible logic resources
- Up to 67,584 internal registers/latches with Clock Enable
- Up to 67,584 look-up tables (LUTs) or cascadable 16-bit shift registers
- Wide multiplexers and wide-input function support
- Horizontal cascade chain and sum-of-products support
- Internal 3-state busing
- High-performance clock management circuitry
 - Up to 12 DCM (Digital Clock Manager) modules
 - Precise clock de-skew
 - Flexible frequency synthesis
 - High-resolution phase shifting
 - 16 global clock multiplexer buffers
- Active interconnect technology
 - Fourth-generation segmented routing structure
 - Predictable, fast routing delay, independent of fanout
- SelectIO™-Ultra Technology
 - Up to 824 user I/Os
 - 19 single-ended and six differential standards
 - Programmable sink current (2 mA to 24 mA) per I/O
 - Digitally Controlled Impedance (DCI) I/O: on-chip termination resistors for single-ended I/O standards
 - PCI compliant (32/33 MHz) at 3.3V
 - Differential signaling
 - 622 Mb/s Low-Voltage Differential Signaling I/O (LVDS) with current mode drivers
 - Bus LVDS I/O
 - Lightning Data Transport (LDT) I/O with current driver buffers
 - Low-Voltage Positive Emitter-Coupled Logic (LVPECL) I/O
 - Built-in DDR input and output registers
 - Proprietary high-performance SelectLink Technology
 - High-bandwidth data path
 - Double Data Rate (DDR) link
 - Web-based HDL generation methodology
- Supported by Xilinx Foundation Series™ and Alliance Series™ Development Systems
 - Integrated VHDL and Verilog design flows
 - Compilation of 10M system gates designs
 - Internet Team Design (ITD) tool

Example: XQ2V3000 -4 CG 717 M

Device Type	_____	Temperature Range/Grade
Speed Grade ⁽¹⁾	_____	Number of Pins
	_____	Package Type

Notes:

1. -4 and -5 are the only supported speed grades.